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Atty. Dkt. No. 039153-0457 (G1162)

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Lopatin et al.

Title: METHOD OF USING TERNARY
COPPER ALLOY TO OBTAIN A
LOW RESISTANCE AND LARGE
GRAIN SIZE INTERCONNECT

Appl. No.: 09/994,395

Filing Date: 11/26/2001

Examiner: Unknown

Art Unit: Unknown

CERTIFICATE OF MAILING I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on the date below. SANDRA A. MURPHY (Printed Name) Sandra A. Murphy (Signature) October 22, 2002 (Date of Deposit)

REQUEST TO RESCIND PREVIOUS NONPUBLICATION REQUEST

35 U.S.C. 122(b)(2)(B)(ii)

Commissioner for Patents
Washington, D.C. 20231

Sir:

Applicants hereby rescind the previous request that the above-identified application not be published under 35 U.S.C. 122(b).

Respectfully submitted,

Date Oct. 22, 2002

By

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